

#### ■ H C P wire

The core material is a soft steel wire (JIS-G-3505) and solders copper thickly on the surface of this core wire.

Mainly, this wire is used under harder condition and the electro conductivity is 30%. Since the core material is steel, and also, self-sustaining property is most suitable for leading wires of the electronic components.

#### ■ P B W

The material (JIS-C-5191) has it's own spring character, which is strong for bending force and is excellent in anti-corrosive requirement, higher soldering requirement and easier bending treatment.

The electro conductivity is 14%.

#### ■ Harder Copper Wire (HFR)

The material (JIS-C-1100) has better conductivity for electric & heat and, also this material has better elongation as well as anti-corrosive property.